MSKSEMI















ESD

TVS

TSS

MOV

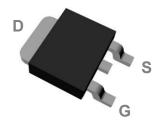
GDT

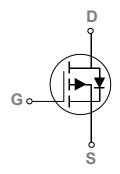
PLED

Broduct data sheet



TO252 Pin Configuration





Features

- -60V,-14A, $RDS(ON) = 68m\Omega@VGS = -10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

Applications

- Motor Drive
- Power Tools
- LED Lighting

BVDSS	RDSON	ID
-60V	55m Ω	-14A

Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-60	V
V _G s	Gate-Source Voltage	±20	V
	Drain Current – Continuous (Tc=25°C)	-14	А
ID	Drain Current – Continuous (Tc=100°C)	-8	А
I _{DM}	Drain Current – Pulsed ¹	-52	А
EAS	Single Pulse Avalanche Energy ²	31	mJ
IAS	Single Pulse Avalanche Current ²	-25	А
D	Power Dissipation (T _C =25°C)	20	W
P _D	Power Dissipation – Derate above 25°C	0.16	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
R _θ JA	Thermal Resistance Junction to ambient		62	°C/W
Rejc	Thermal Resistance Junction to Case		6.1	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-60			V
△BV _{DSS} /△T _J	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =-1mA		-0.05		V/°C
1	Prain Source Leekage Current	V _{DS} =-60V , V _{GS} =0V , T _J =25°C			-1	uA
I _{DSS} Drain-Source Leakage Current	V _{DS} =-48V , V _{GS} =0V , T _J =125°C			-10	uA	
Igss	Gate-Source Leakage Current	V_{GS} =±20 V , V_{DS} =0 V			±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-10V , I _D =-6A		55	65	mΩ
RDS(ON)	Static Drain-Source On-Resistance	V _{GS} =-4.5V , I _D =-3A		65	80	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA		-1.5	-2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			5		mV/°C
gfs	Forward Transconductance	V _{DS} =-10V , I _D =-6A		8.5		S

Dynamic and switching Characteristics

- ya	dia switching characteris	1100			
Qg	Total Gate Charge ^{3, 4}			16.4	
Q _{gs}	Gate-Source Charge ^{3, 4}	V_{DS} =-30V , V_{GS} =-10V , I_{D} =-6A		2.8	nC
Q _{gd}	Gate-Drain Charge ^{3, 4}			3.6	
T _{d(on)}	Turn-On Delay Time ^{3 , 4}			8.3	
Tr	Rise Time ^{3, 4}	V_{DD} =-30 V , V_{GS} =-10 V , R_{G} =6 Ω		29.6	
T _{d(off)}	Turn-Off Delay Time ^{3, 4}	I _D =-1A		51.7	ns
T _f	Fall Time ^{3, 4}			15.6	
C _{iss}	Input Capacitance			870	
Coss	Output Capacitance	V _{DS} =-30V , V _{GS} =0V , F=1MHz		70	pF
Crss	Reverse Transfer Capacitance			42	
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz		16	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V . Force Current			-14	Α
I _{SM}	Pulsed Source Current	VG-VD-0V , Force Current			-52	Α
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =-1A , T _J =25°C			-1	V

Note:

- 1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
- 2. V_{DD} =-25V, V_{GS} =-10V,L=0.1mH, I_{AS} =-25A., R_{G} =25 Ω ,Starting T_{J} =25 $^{\circ}$ C.
- 3. The data tested by pulsed, pulse width \leq 300us, duty cycle \leq 2%.
- Essentially independent of operating temperature.



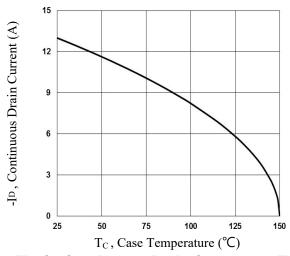


Fig.1 Continuous Drain Current vs. T_c

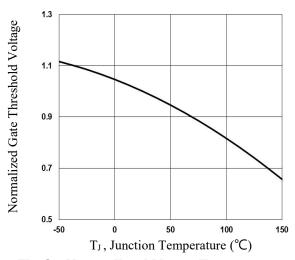


Fig.3 Normalized V_{th} vs. T_J

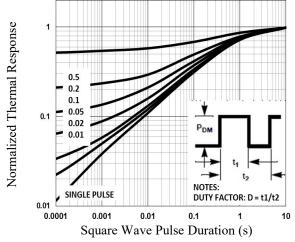


Fig.5 Normalized Transient Impedance

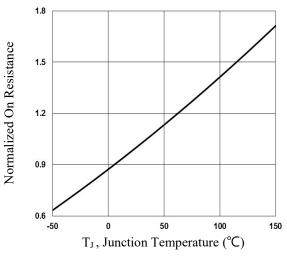


Fig.2 Normalized RDSON vs. TJ

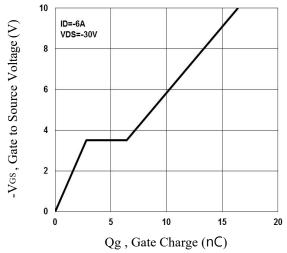


Fig.4 Gate Charge Waveform

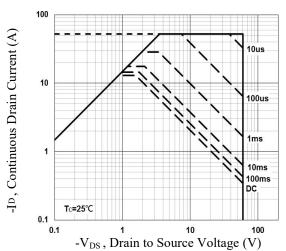


Fig.6 Maximum Safe Operation Area



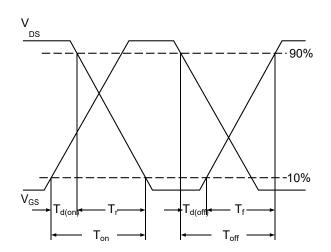


Fig.7 Switching Time Waveform

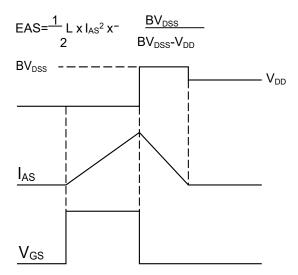
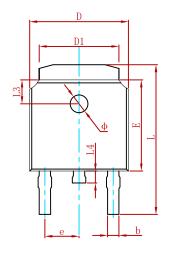
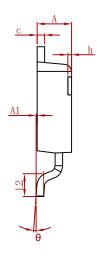


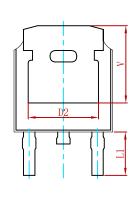
Fig.8 EAS Waveform



PACKAGE MECHANICAL DATA

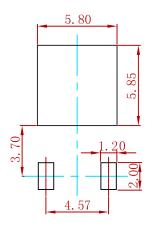






Cumbal	Dimensions In Millimeters		Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830	REF.	0.190	REF.
Е	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.712	10.312	0.382	0.406
L1	2.900 REF.		0.114	REF.
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063	REF.
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207	REF.

Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
AOD407-MS	TO-252	2500



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BSS340NWH6327XTSA1 MCM3400A-TP DMTH10H4M6SPS-13 IRF40SC240ARMA1 IPS60R1K0PFD7SAKMA1

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